

# TC74HC193AP, TC74HC193AF, TC74HC193AFN

## SYNCHRONOUS UP/DOWN BINARY COUNTER

The TC74HC193A are high speed CMOS SYNCHRONOUS 4-BIT UP/DOWN COUNTER fabricated with silicon gate C<sup>2</sup>MOS technology.

It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

They have a clear input (CLR), a load input ( $\overline{\text{LOAD}}$ ), load data inputs (A ~ D), two clock inputs (COUNT UP, COUNT DOWN), four count data outputs (QA ~ QD), and other outputs ( $\overline{\text{CARRY}}$ ,  $\overline{\text{BORROW}}$ ).

CLEAR is active high and forces QA thru QD outputs low independent of the other inputs.

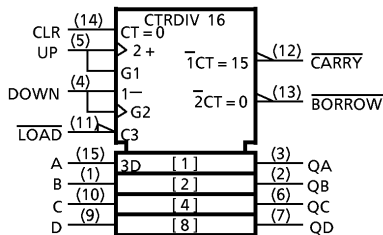
$\overline{\text{CARRY}}$  and  $\overline{\text{BORROW}}$  outputs are provided in order to make a cascade connection without external circuitry.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

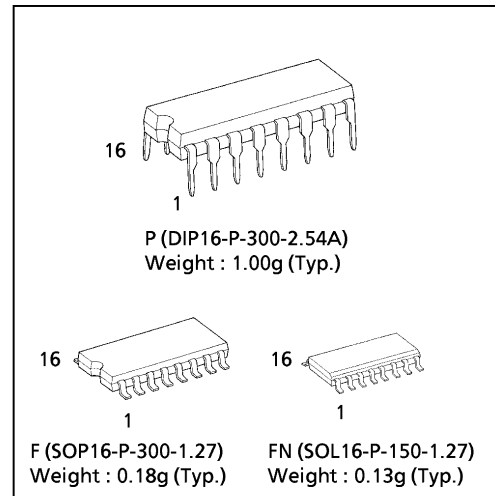
### FEATURES :

- High Speed..... $f_{\text{MAX}} = 54\text{MHz}$  (typ.)  
at  $V_{\text{CC}} = 5\text{V}$
- Low Power Dissipation..... $I_{\text{CC}} = 4\mu\text{A}$ (Max.) at  $T_a = 25^\circ\text{C}$
- High Noise Immunity..... $V_{\text{NIH}} = V_{\text{NIL}} = 28\% V_{\text{CC}}$  (Min.)
- Output drive Capability..... 10 LSTTL Loads
- Symmetrical Output Impedance...  $|I_{\text{OH}}| = I_{\text{OL}} = 4\text{mA}$  (Min.)
- Balanced Propagation Delays.....  $t_{\text{pLH}} \approx t_{\text{pHL}}$
- Wide Operating Voltage Range...  $V_{\text{CC}} (\text{opr.}) = 2\text{V} \sim 6\text{V}$
- Pin and Function Compatible with 74LS193

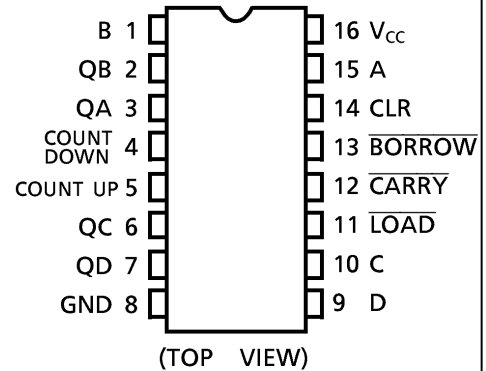
### IEC LOGIC SYMBOL



(Note) The JEDEC SOP (FN) is not available in Japan.



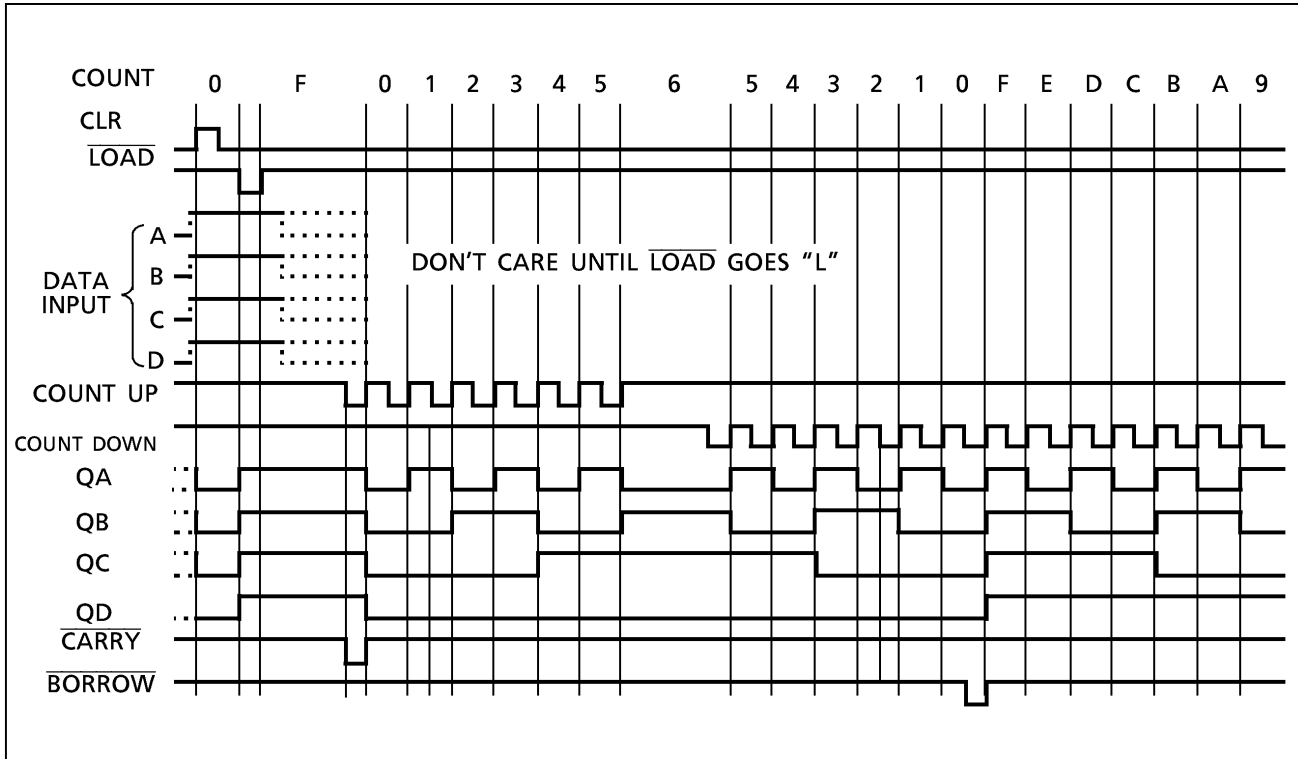
### PIN ASSIGNMENT



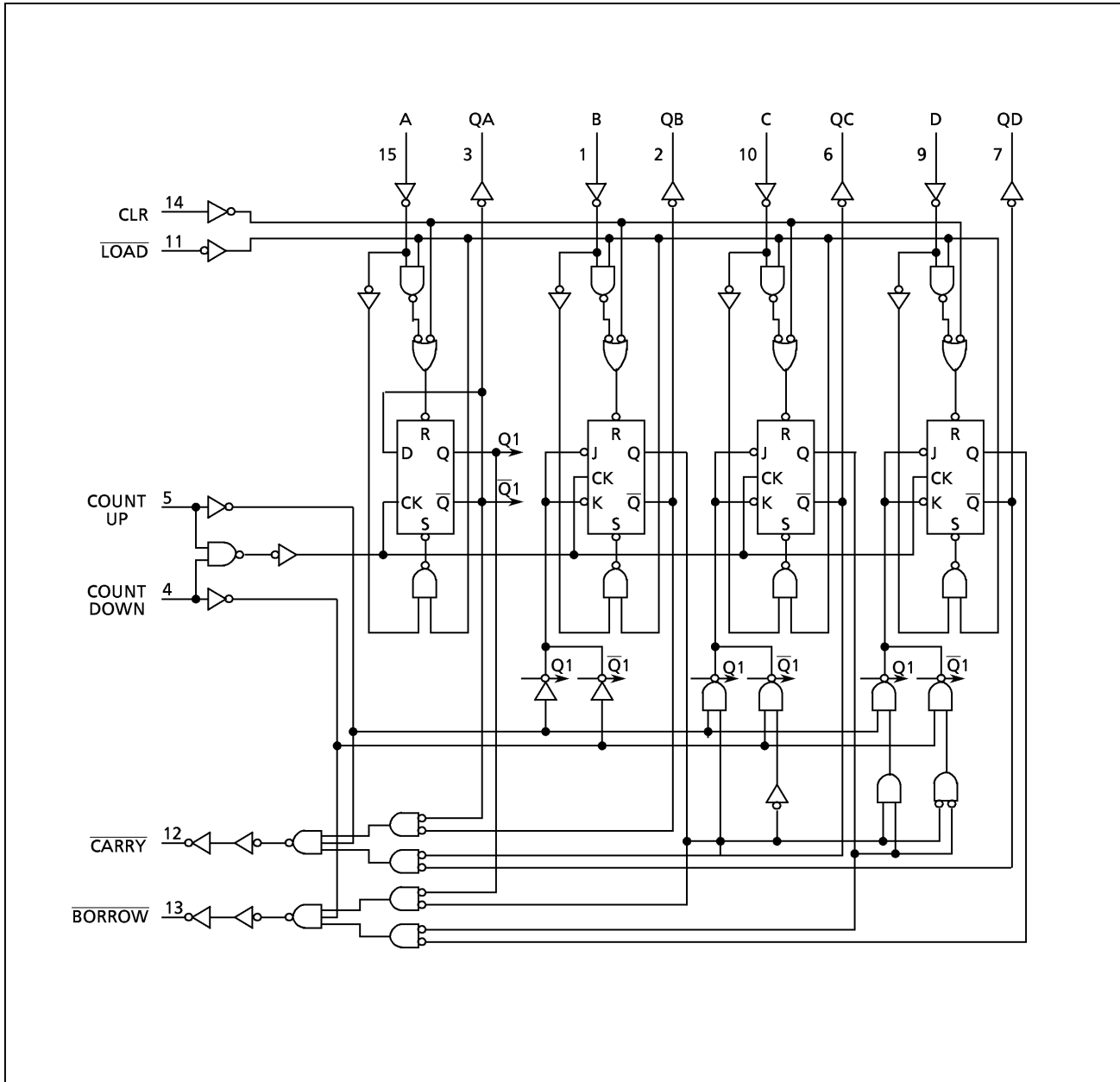
### TRUTH TABLE

INPUTS				FUNCTION
COUNT UP	COUNT DOWN	$\overline{\text{LOAD}}$	CLR	
	H	H	L	COUNT UP
	H	H	L	NO COUNT
H		H	L	COUNT DOWN
H		H	L	NO COUNT
X	X	L	L	PRESET
X	X	X	H	RESET

**TIMING CHART**



**SYSTEM DIAGRAM**



## ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	VALUE	UNIT
Supply Voltage Range	$V_{CC}$	-0.5~7	V
DC Input Voltage	$V_{IN}$	-0.5~ $V_{CC} + 0.5$	V
DC Output Voltage	$V_{OUT}$	-0.5~ $V_{CC} + 0.5$	V
Input Diode Current	$I_{IK}$	± 20	mA
Output Diode Current	$I_{OK}$	± 20	mA
DC Output Current	$I_{OUT}$	± 25	mA
DC $V_{CC}$ / Ground Current	$I_{CC}$	± 50	mA
Power Dissipation	$P_D$	500 (DIP)* / 180 (SOP)	mW
Storage Temperature	$T_{stg}$	-65~150	°C

\*500mW in the range of  $T_a = -40^{\circ}\text{C} \sim 65^{\circ}\text{C}$ . From  $T_a = 65^{\circ}\text{C}$  to  $85^{\circ}\text{C}$  a derating factor of  $-10\text{mW}/^{\circ}\text{C}$  shall be applied until 300mW.

## RECOMMENDED OPERATING CONDITIONS

PARAMETER	SYMBOL	VALUE	UNIT
Supply Voltage	$V_{CC}$	2~6	V
Input Voltage	$V_{IN}$	0~ $V_{CC}$	V
Output Voltage	$V_{OUT}$	0~ $V_{CC}$	V
Operating Temperature	$T_{opr}$	-40~85	°C
Input Rise and Fall Time	$t_r, t_f$	0~ 1000 ( $V_{CC} = 2.0\text{V}$ ) 0~ 500 ( $V_{CC} = 4.5\text{V}$ ) 0~ 400 ( $V_{CC} = 6.0\text{V}$ )	ns

## DC ELECTRICAL CHARACTERISTICS

PARAMETER	SYMBOL	TEST CONDITION	$V_{CC}$ (V)	$T_a = 25^{\circ}\text{C}$			$T_a = -40 \sim 85^{\circ}\text{C}$		UNIT	
				MIN.	TYP.	MAX.	MIN.	MAX.		
High - Level Input Voltage	$V_{IH}$		2.0	1.50	—	—	1.50	—	V	
			4.5	3.15	—	—	3.15	—		
			6.0	4.20	—	—	4.20	—		
Low - Level Input Voltage	$V_{IL}$		2.0	—	—	0.50	—	0.50	V	
			4.5	—	—	1.35	—	1.35		
			6.0	—	—	1.80	—	1.80		
High - Level Output Voltage	$V_{OH}$	$V_{IN} = V_{IH}$ or $V_{IL}$	$I_{OH} = -20\mu\text{A}$	2.0	1.9	2.0	—	1.9	—	V
				4.5	4.4	4.5	—	4.4	—	
				6.0	5.9	6.0	—	5.9	—	
Low - Level Output Voltage	$V_{OL}$	$V_{IN} = V_{IH}$ or $V_{IL}$	$I_{OL} = 20\mu\text{A}$	2.0	—	0.0	0.1	—	0.1	V
				4.5	—	0.0	0.1	—	0.1	
				6.0	—	0.0	0.1	—	0.1	
Input Leakage Current	$I_{IN}$	$V_{IN} = V_{CC}$ or GND	6.0	—	—	± 0.1	—	± 1.0	$\mu\text{A}$	
			Quiescent Supply Current	$I_{CC}$	$V_{IN} = V_{CC}$ or GND	6.0	—	—		4.0

TIMING REQUIREMENTS (Input  $t_r = t_f = 6\text{ns}$ )

PARAMETER	SYMBOL	TEST CONDITION	Ta = 25°C			Ta = -40~85°C		UNIT
			V <sub>CC</sub> (V)	TYP.	LIMIT	LIMIT		
Minimum Pulse Width (CK)	$t_{W(H)}$ $t_{W(L)}$		2.0	—	100	125	ns	
			4.5	—	20	25		
			6.0	—	17	21		
Minimum Pulse Width (LOAD)	$t_{W(L)}$		2.0	—	75	95		
			4.5	—	15	19		
			6.0	—	13	16		
Minimum Hold Time (CLR)	$t_{W(H)}$		2.0	—	100	125		
			4.5	—	20	25		
			6.0	—	17	21		
Minimum Set-up Time (DATA-LOAD)	$t_s$		2.0	—	75	95		
			4.5	—	15	19		
			6.0	—	13	16		
Minimum Hold Time (DATA-LOAD)	$t_h$		2.0	—	0	0		
			4.5	—	0	0		
			6.0	—	0	0		
Minimum Removal Time (LOAD)	$t_{rem}$		2.0	—	50	65		
			4.5	—	10	13		
			6.0	—	9	10		
Minimum Removal Time (CLR)	$t_{rem}$		2.0	—	50	65		
			4.5	—	10	13		
			6.0	—	9	10		
Clock Frequency	f		2.0	—	5	4	MHz	
			4.5	—	25	20		
			6.0	—	29	24		

AC ELECTRICAL CHARACTERISTICS (  $C_L = 15\text{pF}$ ,  $V_{CC} = 5\text{V}$ ,  $T_a = 25^\circ\text{C}$ , Input  $t_r = t_f = 6\text{ns}$  )

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Output Transition Time	$t_{TLH}$ $t_{THL}$		—	6	12	ns
Propagation Delay Time (UP, DOWN—Q)	$t_{pLH}$ $t_{pHL}$		—	16	33	
Propagation Delay Time (UP— $\overline{\text{CARRY}}$ )	$t_{pLH}$ $t_{pHL}$		—	10	22	
Propagation Delay Time (DOWN—BORROW)	$t_{pLH}$ $t_{pHL}$		—	10	22	
Propagation Delay Time (LOAD—Q)	$t_{pLH}$ $t_{pHL}$		—	21	38	
Propagation Delay Time (LOAD— $\overline{\text{CARRY}}$ )	$t_{pLH}$ $t_{pHL}$		—	25	44	
Propagation Delay Time (LOAD—BORROW)	$t_{pLH}$ $t_{pHL}$		—	26	44	
Propagation Delay Time (DATA IN—Q)	$t_{pLH}$ $t_{pHL}$		—	21	33	
Propagation Delay Time (DATA IN— $\overline{\text{CARRY}}$ )	$t_{pLH}$ $t_{pHL}$		—	29	44	
Propagation Delay Time (DATA IN—BORROW)	$t_{pLH}$ $t_{pHL}$		—	26	44	
Propagation Delay Time (CLR—Q)	$t_{pHL}$		—	25	39	
Propagation Delay Time (CLR— $\overline{\text{CARRY}}$ )	$t_{pLH}$		—	30	44	
Propagation Delay Time (CLR—BORROW)	$t_{pHL}$		—	30	44	
Maximum Clock Frequency	$f_{MAX}$		27	52	—	MHz

**AC ELECTRICAL CHARACTERISTICS (C<sub>L</sub> = 50pF, Input t<sub>r</sub> = t<sub>f</sub> = 6ns)**

PARAMETER	SYMBOL	TEST CONDITION	Ta = 25°C			Ta = -40~85°C		UNIT	
			V <sub>CC</sub> (V)	MIN.	TYP.	MAX.	MIN.		MAX.
Output Transition Time	t <sub>TLH</sub> t <sub>THL</sub>		2.0	—	30	75	—	95	ns
			4.5	—	8	15	—	19	
			6.0	—	7	13	—	16	
Propagation Delay Time (UP, DOWN—Q)	t <sub>pLH</sub> t <sub>pHL</sub>		2.0	—	65	190	—	240	
			4.5	—	20	38	—	48	
			6.0	—	16	32	—	41	
Propagation Delay Time (UP—CARRY)	t <sub>pLH</sub> t <sub>pHL</sub>		2.0	—	40	130	—	165	
			4.5	—	13	26	—	33	
			6.0	—	11	22	—	28	
Propagation Delay Time (DOWN—BORROW)	t <sub>pLH</sub> t <sub>pHL</sub>		2.0	—	40	130	—	165	
			4.5	—	13	26	—	33	
			6.0	—	11	22	—	28	
Propagation Delay Time (LOAD—Q)	t <sub>pLH</sub> t <sub>pHL</sub>		2.0	—	85	220	—	275	
			4.5	—	25	44	—	55	
			6.0	—	20	37	—	47	
Propagation Delay Time (LOAD—CARRY)	t <sub>pLH</sub> t <sub>pHL</sub>		2.0	—	110	250	—	315	
			4.5	—	30	50	—	63	
			6.0	—	25	43	—	54	
Propagation Delay Time (LOAD—BORROW)	t <sub>pLH</sub> t <sub>pHL</sub>		2.0	—	110	250	—	315	
			4.5	—	30	50	—	63	
			6.0	—	25	43	—	54	
Propagation Delay Time (DATA IN—Q)	t <sub>pLH</sub> t <sub>pHL</sub>		2.0	—	80	190	—	240	
			4.5	—	25	38	—	48	
			6.0	—	20	32	—	41	
Propagation Delay Time (DATA IN—CARRY)	t <sub>pLH</sub> t <sub>pHL</sub>		2.0	—	120	250	—	315	
			4.5	—	34	50	—	63	
			6.0	—	28	43	—	54	
Propagation Delay Time (DATA IN—BORROW)	t <sub>pLH</sub> t <sub>pHL</sub>		2.0	—	110	250	—	315	
			4.5	—	31	50	—	63	
			6.0	—	25	43	—	54	
Propagation Delay Time (CLR—Q)	t <sub>pHL</sub>		2.0	—	100	225	—	280	
			4.5	—	30	45	—	56	
			6.0	—	25	38	—	48	
Propagation Delay Time (CLR—CARRY)	t <sub>pLH</sub>		2.0	—	120	250	—	315	
			4.5	—	35	50	—	63	
			6.0	—	29	43	—	54	
Propagation Delay Time (CLR—BORROW)	t <sub>pHL</sub>		2.0	—	120	250	—	315	
			4.5	—	35	50	—	63	
			6.0	—	29	43	—	54	
Maximum Clock Frequency	f <sub>MAX</sub>		2.0	5	12	—	4	—	MHz
			4.5	25	48	—	20	—	
			6.0	29	55	—	24	—	
Input Capacitance	C <sub>IN</sub>		—	5	10	—	10	pF	
Power Dissipation Capacitance	C <sub>PD</sub> (1)		—	67	—	—	—		

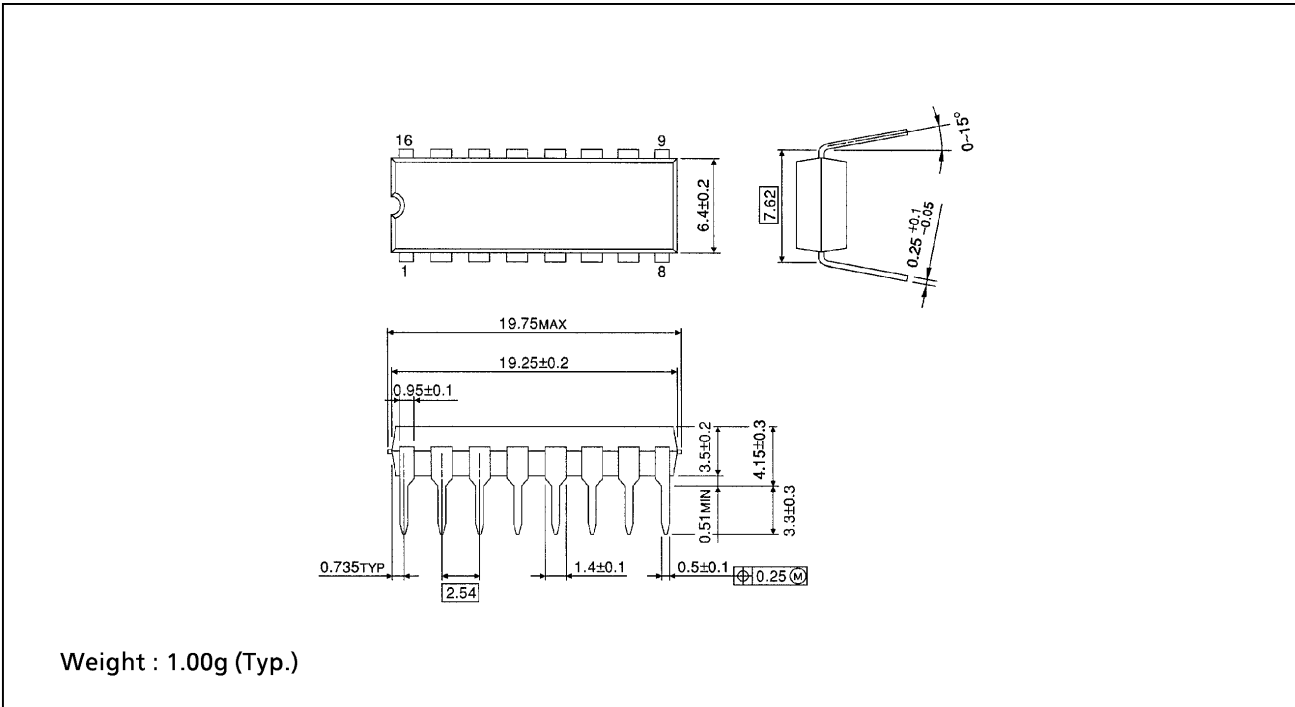
Note (1) C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation :

$$I_{CC} (opr) = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$$

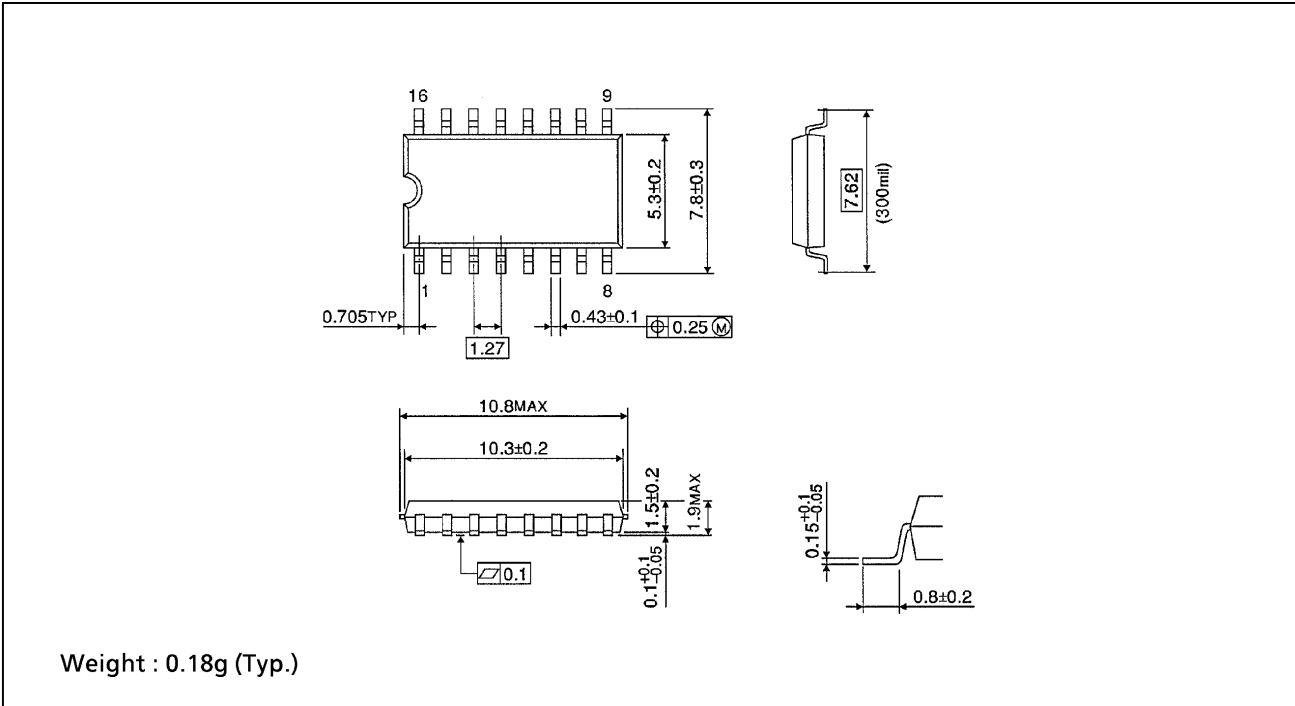
**DIP 16PIN PACKAGE DIMENSIONS (DIP16-P-300-2.54A)**

Unit in mm



**SOP 16PIN (200mil BODY) PACKAGE DIMENSIONS (SOP16-P-300-1.27)**

Unit in mm

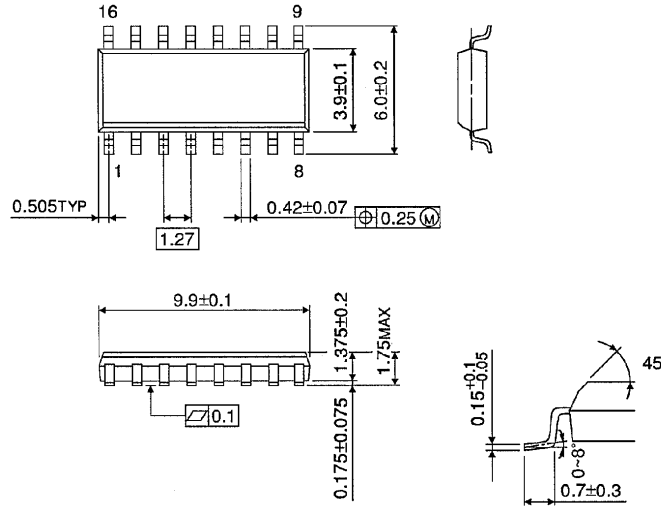




**SOP 16PIN (150mil BODY) PACKAGE DIMENSIONS (SOL16-P-150-1.27)**

Unit in mm

(Note) This package is not available in Japan.



Weight : 0.13g (Typ.)

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